DECLARATION FOR PATENT APPLICATION

. Yo a perow Hamed Inventor,	I hereby declare that.		
My residence, post office	address and citizenship	are as stated below nex	ct to my name.
I believe I am the original below) or an original, first the subject matter which is entitled: MICROPARTICLES THEREOF	st and joint inventor (i s claimed and for which	f plural names are list a patent is sought on t	ted below) of the invention
the specification of which applicable).	(check one) X is at ion Serial No.	tached heretowas i	filed on ed on (if
I hereby state that I have identified specification,			
I acknowledge the duty to this application in accordance 1.56(a).			
***************			: 2 %
I hereby claim foreign pri- any foreign application(s) also identified below any having a filing date before	for patent or inventor' foreign application for	s certificate listed be patent or inventor's ce	elow and have extificate
Prior Foreign Application(Number Country	s) Day/Month/Year Fil	ed <u>Yes</u>	No No
		:====================================	
I hereby claim the benefit States application(s) list claims of this application the manner provided by the acknowledge the duty to di Federal Regulations, \$1.56 application and the nation	ed below and, insofar as is not disclosed in the first paragraph of Titl sclose material informat (a) which occurred betwe	the subject matter of prior United States and e 35, United States Code ion as defined in Title en the filing date of the states	each of the oplication in le, \$112, I e 37, Code of the prior
Application Serial No. Fil	ing Date	Status Patented, Pending, Aba	andoned
I hereby claim the benefit States application(s) list claims of this application the manner provided by the acknowledge the duty to diffederal Regulations, \$1.56 application and the nation	ed below and, insofar as is not disclosed in the first paragraph of Titlesclose material information which occurred between	the subject matter of prior United States apple 35, United States Continued in Title en the filing date of	each of the pplication in de, \$112, I a second of the prior
Application Serial No. Fil	ing Date	Status Patented, Pending, Ab	andoned
60/069,749 Decembra 09/015,652 Januar 09/124,533 July 2	cy 30, 1997 Der 16, 1997 Cy 29, 1998 29, 1998 2, 1999	X X X	X X

PATENT

Atty. Docket No. 1388.202

I hereby declare that all statements herein of my own knowledge are true and that all istatements made on information and belief are believed to be true; and further that these statements and the like so made are punishable by fine or imprisonment or both, under Section 1001 of Title 18 of the United States code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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